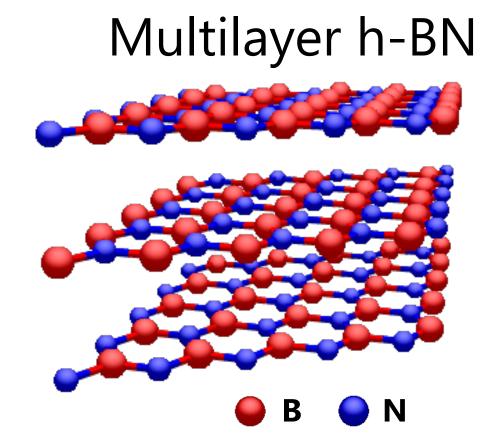
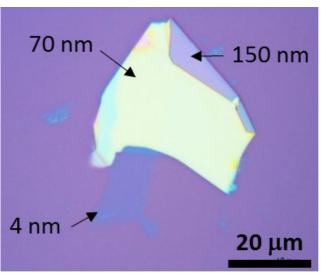
Multilayer Hexagonal Boron Nitride (h-BN) New CVD Synthesis Methods for Large-area, Multilayer h-BN

1. Importance of Hexagonal Boron Nitride (h-BN)



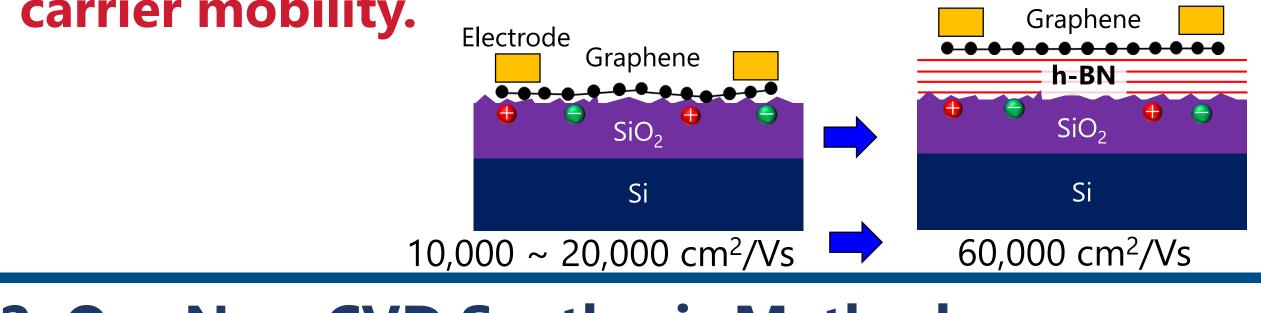
× Mechanical Exfoliation can provide only very small h-BN flakes. > Two-dimensional insulator with large band gap (5.9eV), atomically flat and dangling-bond-free surface

Excellent Insulating material for graphene, TMDC and other 2D materials **TMDC**: **T**ransition **M**etal **D**i**C**halcogenide

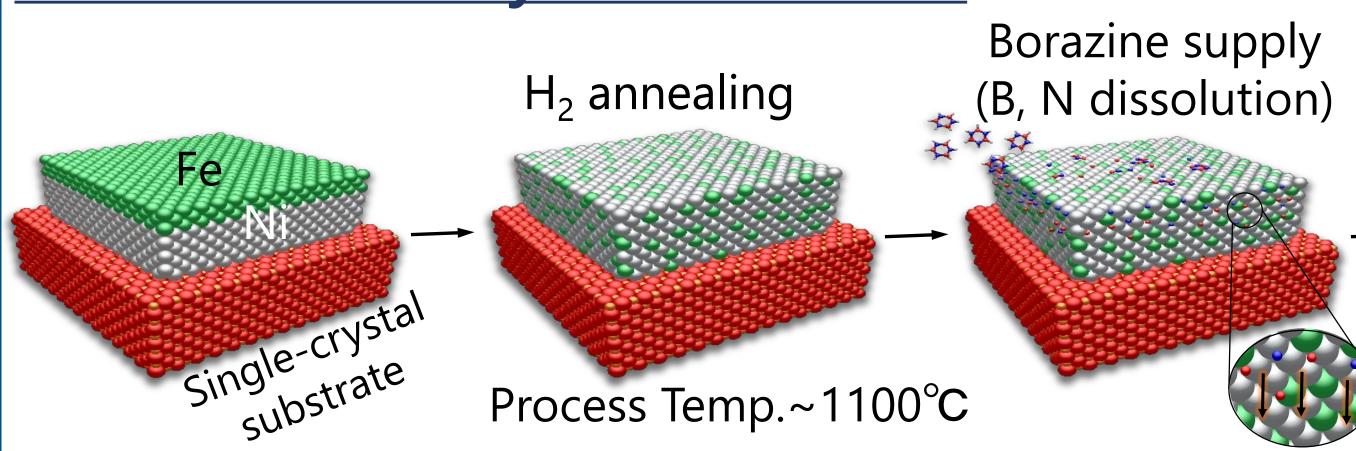


 \times CVD method can usually give monolayer h-BN, which is not thick enough.

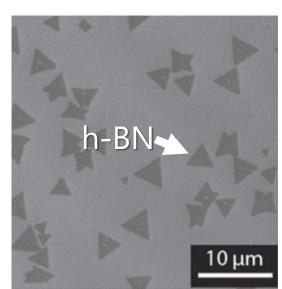
Large-area and multilayer h-BN can reduce surface roughness, optical phonon and charge impurities of SiO₂ surface, and can increase the carrier mobility.



2. Our New CVD Synthesis Method

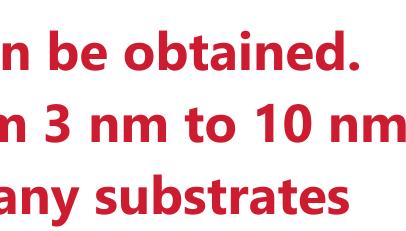


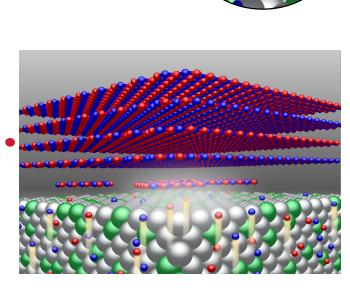
Large area & uniform multilayer h-BN can be obtained. Typical thickness of the h-BN ranges from 3 nm to 10 nm. The h-BN can be easily transferred onto any substrates by wet process.



C. R. Dean et al., Nat. Nanotech., 5, 722 (2010)

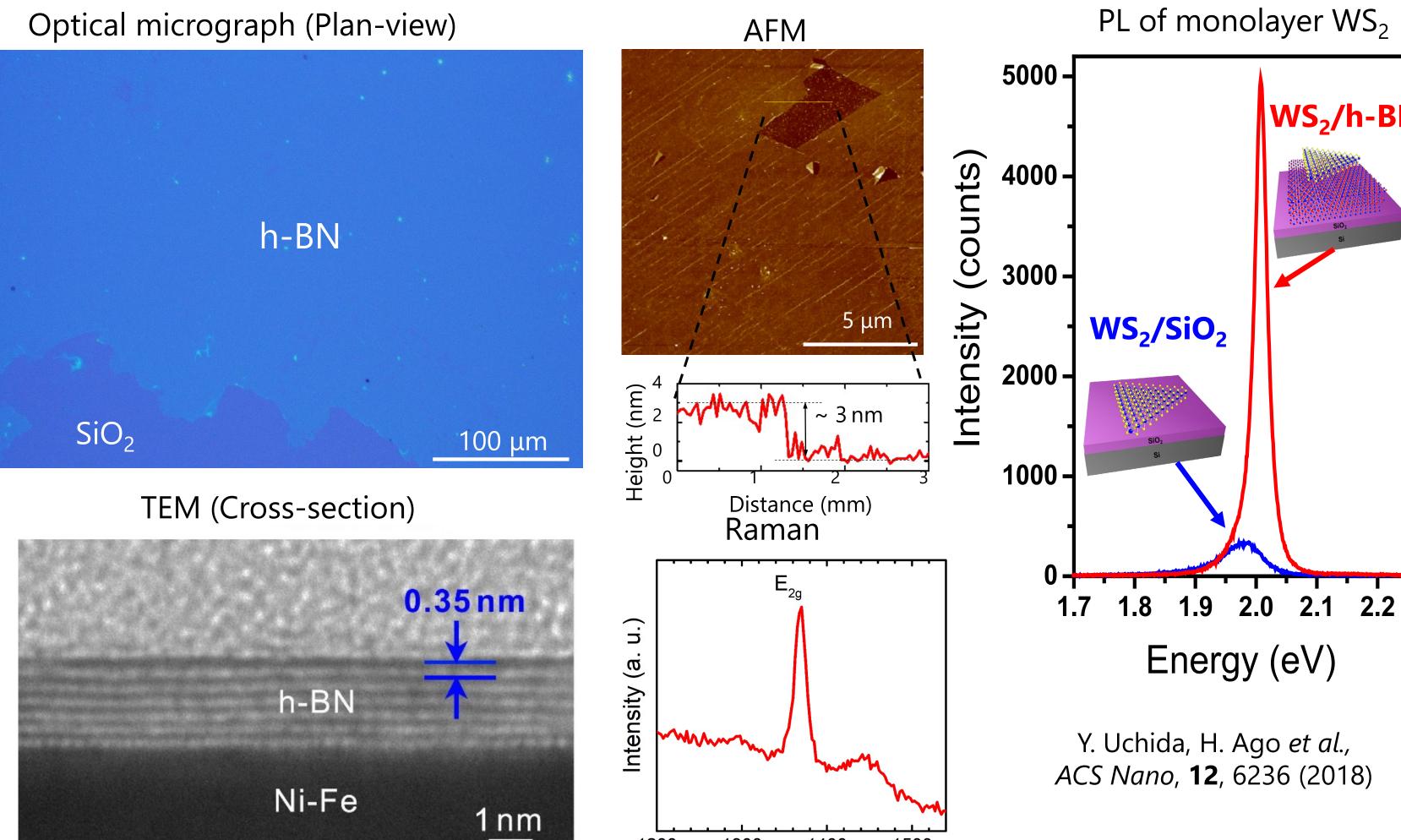
> Slow cooling 5°C/min (B, N segregation)

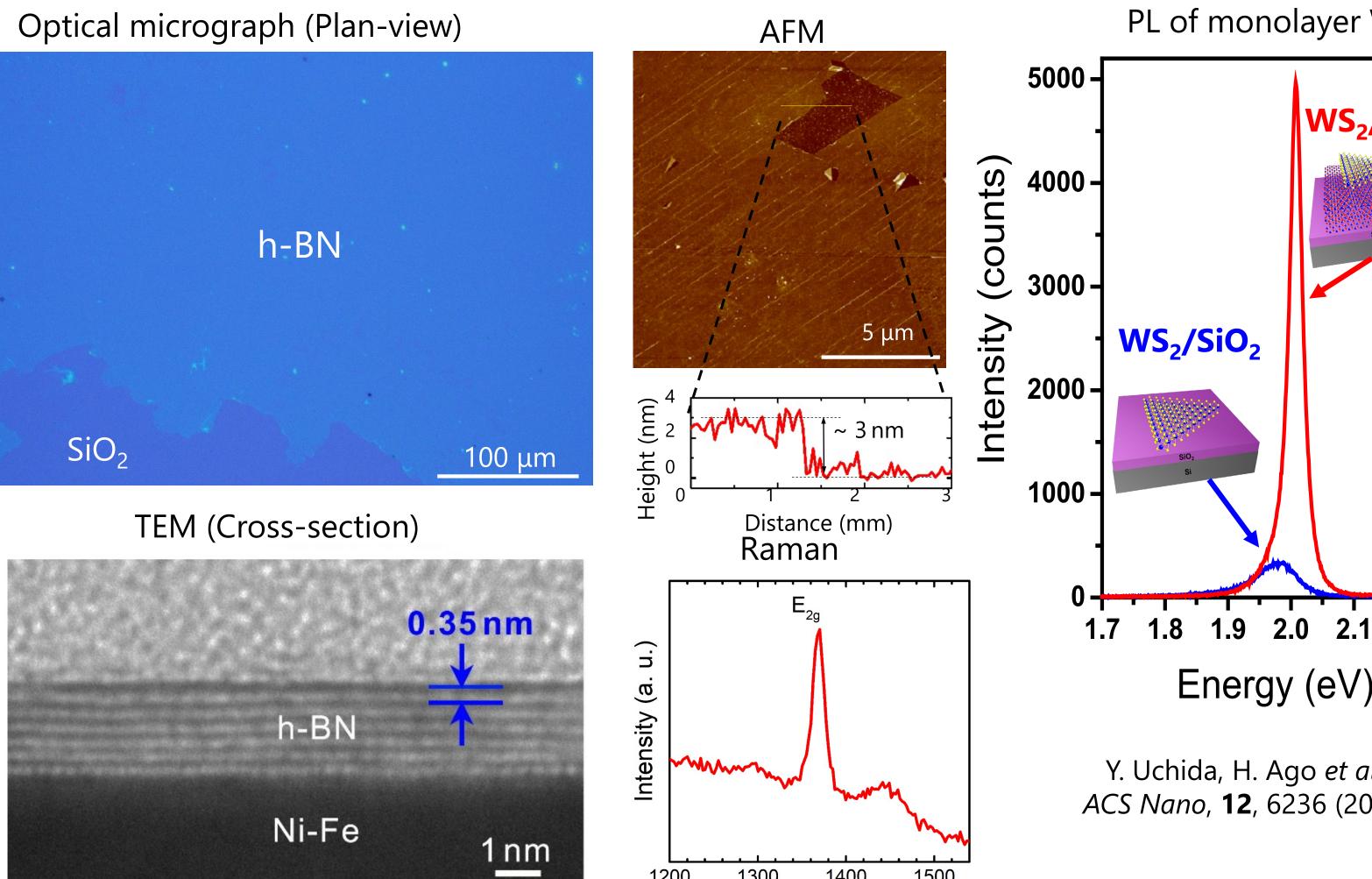




Prof. Hiroki AGO (Kyushu University) **3.h-BN Quality of This Method and Prospective Applications**

The below experimental data shows the quality of the h-BN





Prospective Applications;

- membrane

4. Patent Licensing Available

Patent No.: WO2018/128193 (JP, US, EP, KR, CN,) JST/ IP Management and Licensing Group Phone: +81-3-5214-8486 E-mail: license@jst.go.jp

http://www.jst.go.jp/chizai/en

Ideal insulator layer of hetero-structured 2D device **Tunneling barrier for spin memory device Light emitting layer of deep ultraviolet device** Oxidation-resistant coating for black phosphorus thin layer device Highly selective proton permeation for polymer electrolyte

Raman shift (cm⁻¹



